

February 1996

## MM78C29/MM88C29 Quad Single-Ended Line Driver MM78C30/MM88C30 Dual Differential Line Driver

### General Description

The MM78C30/MM88C30 is a dual differential line driver that also performs the dual four-input NAND or dual four-input AND function. The absence of a clamp diode to  $V_{CC}$  in the input protection circuitry of the MM78C30/MM88C30 allows a CMOS user to interface systems operating at different voltage levels. Thus, a CMOS digital signal source can operate at a  $V_{CC}$  voltage greater than the  $V_{CC}$  voltage of the MM78C30 line driver. The differential output of the MM78C30/MM88C30 eliminates ground-loop errors.

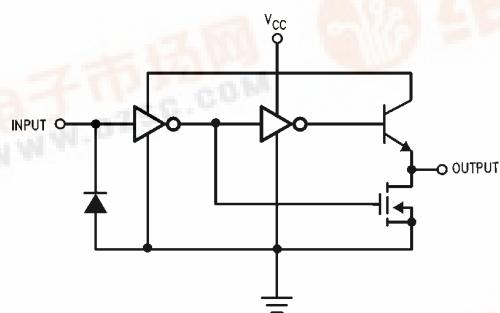
The MM78C29/MM88C29 is a non-inverting single-wire transmission line driver. Since the output ON resistance is a low  $20\Omega$  typ., the device can be used to drive lamps, relays, solenoids, and clock lines, besides driving data lines.

### Features

- Wide supply voltage range                                    3V to 15V
- High noise immunity                                        0.45  $V_{CC}$  (typ.)
- Low output ON resistance                                     $20\Omega$  (typ.)

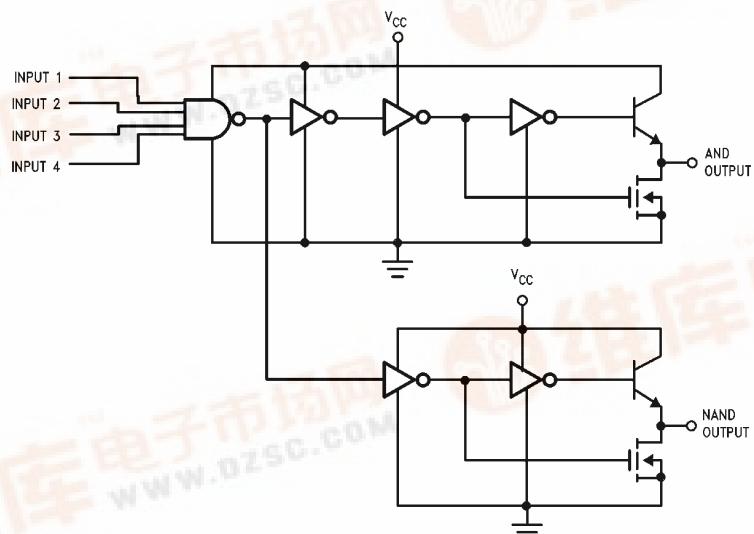
### Logic Diagrams

1/4 MM78C29/MM88C29



TL/F/5908-1

1/2 MM78C30/MM88C30



TL/F/5908-2

**MM78C29/MM88C29 Quad Single-Ended Line Driver  
MM78C30/MM88C30 Dual Differential Line Driver**

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin (Note 1)	-0.3V to V <sub>CC</sub> + 16V	Operating V <sub>CC</sub> Range	3V to 15V
Operating Temperature Range		Absolute Maximum V <sub>CC</sub>	18V
MM78C29/MM78C30	-55°C to + 125°C	Average Current at Output	
MM88C29/MM88C30	-40°C to + 85°C	MM78C30/MM88C30	50 mA
Storage Temperature	-65°C to + 150°C	MM78C29/MM88C29	25 mA
Power Dissipation (P <sub>D</sub> )		Maximum Junction Temperature, T <sub>j</sub>	150°C
Dual-In-Line	700 mW	Lead Temperature	
Small Outline	500 mW	(Soldering, 10 seconds)	260°C

## DC Electrical Characteristics

Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>CMOS TO CMOS</b>						
V <sub>IN(1)</sub>	Logical "1" Input Voltage	V <sub>CC</sub> = 5V V <sub>CC</sub> = 10V	3.5 8			V V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 5V V <sub>CC</sub> = 10V			1.5 2	V V
I <sub>IN(1)</sub>	Logical "1" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 15V		0.005	1	μA
I <sub>IN(0)</sub>	Logical "0" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 0V	-1	-0.005		μA
I <sub>CC</sub>	Supply Current	V <sub>CC</sub> = 5V		0.05	100	mA
<b>OUTPUT DRIVE</b>						
I <sub>SOURCE</sub>	Output Source Current MM78C29/MM78C30	V <sub>OUT</sub> = V <sub>CC</sub> - 1.6V, V <sub>CC</sub> ≥ 4.5V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	-57 -32	-80 -50		mA mA
	MM88C29/MM88C30	V <sub>OUT</sub> = V <sub>CC</sub> - 1.6V, V <sub>CC</sub> ≥ 4.75V, T <sub>j</sub> = 25°C T <sub>j</sub> = 85°C	-47 -32	-80 -60		mA mA
	MM78C29/MM88C29 MM78C30/MM88C30	V <sub>OUT</sub> = V <sub>CC</sub> - 0.8V V <sub>CC</sub> ≥ 4.5V	-2	-20		mA
I <sub>SINK</sub>	Output Sink Current MM78C29/MM78C30	V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 4.5V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	11 8	20 14		mA mA
		V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 10V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	22 16	40 28		mA mA
	MM88C29/MM88C30	V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 4.75V, T <sub>j</sub> = 25°C T <sub>j</sub> = 85°C	9.5 8	22 18		mA mA
		V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 10V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C	19 15.5	40 33		mA mA
I <sub>SOURCE</sub>	Output Source Resistance MM78C29/MM78C30	V <sub>OUT</sub> = V <sub>CC</sub> - 1.6V, V <sub>CC</sub> ≥ 4.5V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C		20 32	28 50	Ω Ω
	MM88C29/MM88C30	V <sub>OUT</sub> = V <sub>CC</sub> - 1.6V, V <sub>CC</sub> ≥ 4.75V, T <sub>j</sub> = 25°C T <sub>j</sub> = 85°C		20 27	34 50	Ω Ω

## DC Electrical Characteristics

Min/Max limits apply across temperature range, unless otherwise noted (Continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OUTPUT DRIVE (Continued)</b>						
I <sub>SINK</sub>	Output Sink Resistance MM78C29/MM78C30	V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 4.50V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C		20	36	Ω
		V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 10V, T <sub>j</sub> = 25°C T <sub>j</sub> = 125°C		28	50	Ω
	MM88C29/MM88C30	V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 4.75V, T <sub>j</sub> = 25°C T <sub>j</sub> = 85°C		10	18	Ω
		V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 10V, T <sub>j</sub> = 25°C T <sub>j</sub> = 85°C		14	25	Ω
	Output Resistance Temperature Coefficient Source Sink			18	41	Ω
				22	50	Ω
				10	21	Ω
				12	26	Ω
			0.55			%/°C
			0.40			%/°C
θ <sub>JA</sub>	Thermal Resistance MM78C29/MM78C30 (D-Package)			100		°C/W
	MM88C29/MM88C30 (N-Package)			150		°C/W

## AC Electrical Characteristics\*

T<sub>A</sub> = 25°C, C<sub>L</sub> = 50 pF

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t <sub>pd</sub>	Propagation Delay Time to Logical “1” or “0” MM78C29/MM88C29	(See Figure 2) V <sub>CC</sub> = 5V V <sub>CC</sub> = 10V		80	200	ns
				35	100	ns
	MM78C30/MM88C30	V <sub>CC</sub> = 5V V <sub>CC</sub> = 10V		110	350	ns
				50	150	ns
t <sub>pd</sub>	Differential Propagation Delay Time to Logical “1” or “0” MM78C30/MM88C30	R <sub>L</sub> = 100Ω, C <sub>L</sub> = 5000 pF (See Figure 1) V <sub>CC</sub> = 5V V <sub>CC</sub> = 10V			400	ns
					150	ns
C <sub>IN</sub>	Input Capacitance MM78C29/MM88C29 MM78C30/MM88C30	(Note 3) (Note 3)		5.0		pF
C <sub>PD</sub>	Power Dissipation Capacitance MM78C29/MM88C29 MM78C30/MM88C30	(Note 3) (Note 3)		150		pF
				200		pF

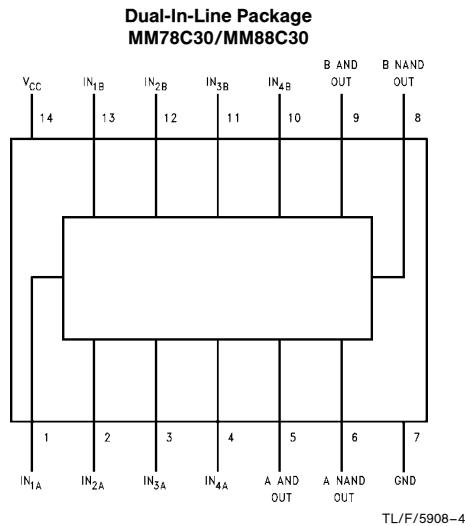
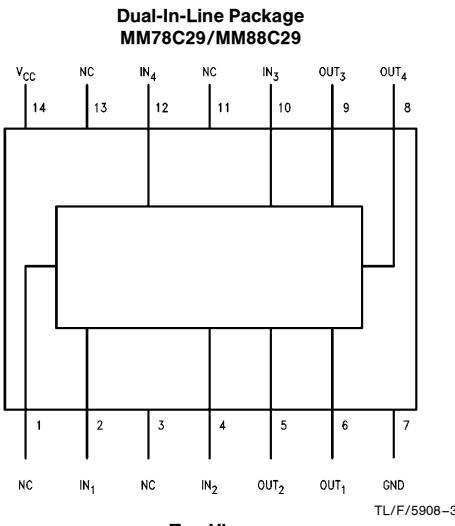
\*AC Parameters are guaranteed by DC correlated testing.

**Note 1:** “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. Except for “Operating Temperature Range” they are not meant to imply that the devices should be operated at these limits. The table of “Electrical Characteristics” provides conditions for actual device operation.

**Note 2:** Capacitance is guaranteed by periodic testing.

**Note 3:** C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics application note AN-90 (CMOS Logic Databook).

## Connection Diagrams



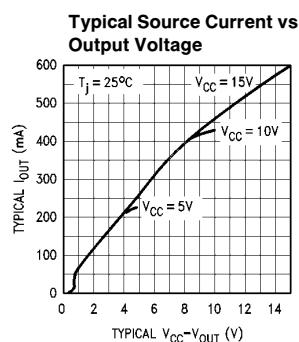
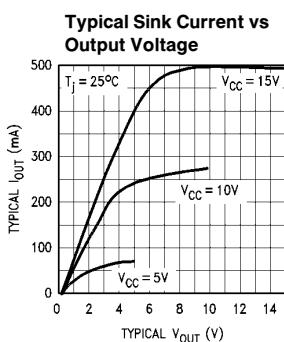
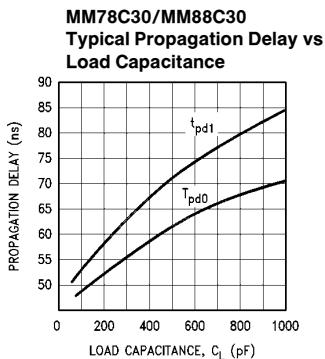
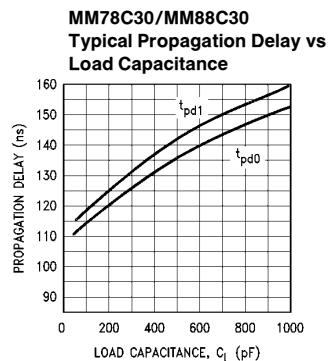
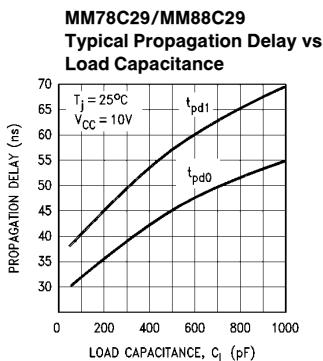
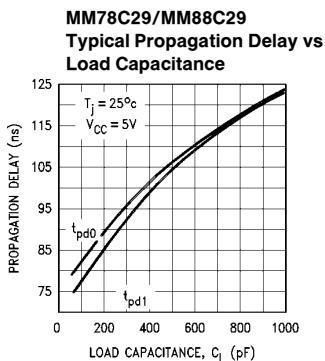
Order Number MM88C29M or MM88C29N

Order Number MM88C30M or MM88C30N

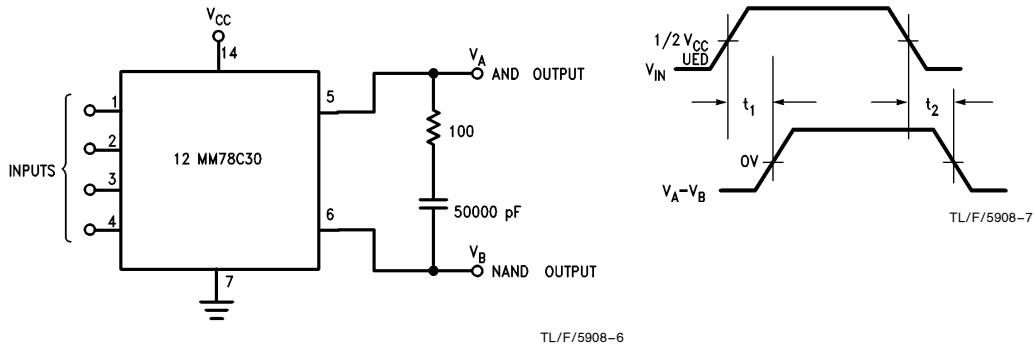
For Complete Military 883 Specifications, see RETS Data Sheet.

Order Number MM78C29J/883, MM78C29W/883, MM78C30J/883 or MM78C30W/883

## Typical Performance Characteristics

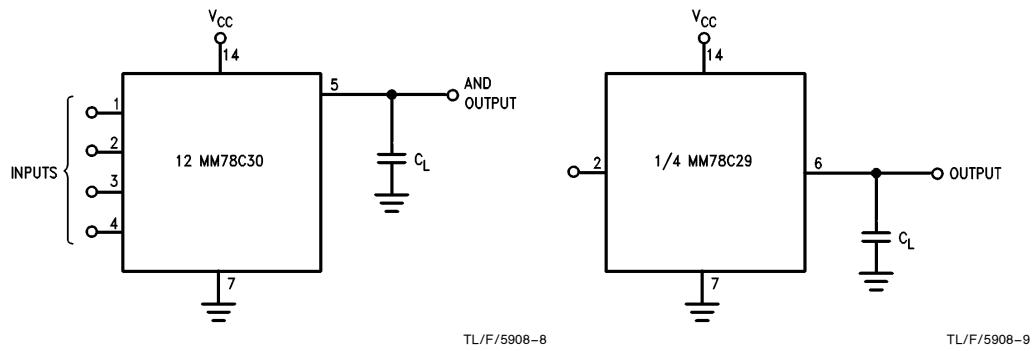


## AC Test Circuits



TL/F/5908-6

**FIGURE 1**

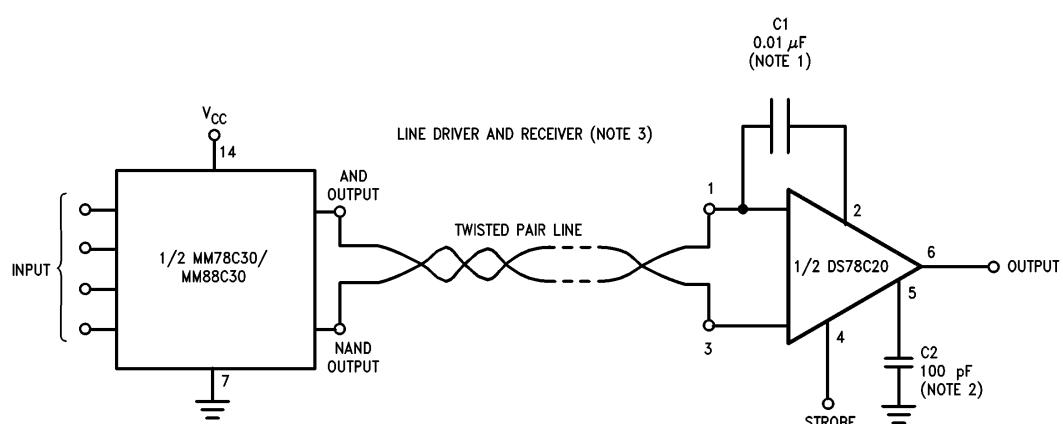


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TL/F/5908-9

## Typical Applications

### Digital Data Transmission

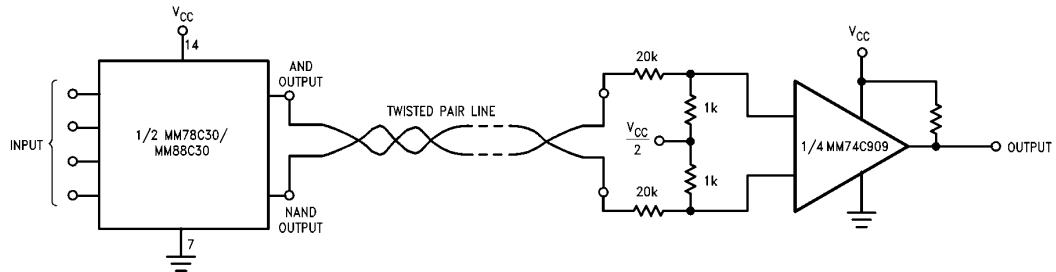


Note 1: Exact value depends on line length.

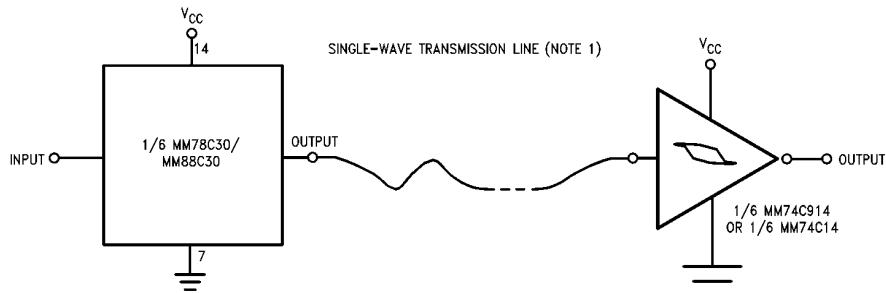
Note 2: Optional to control response time.

Note 3: V<sub>CC</sub> = 4.5V to 5.5V for the DS7820, V<sub>CC</sub> = 4.5V to 15V for the DS78C20.

## Typical Applications (Continued)



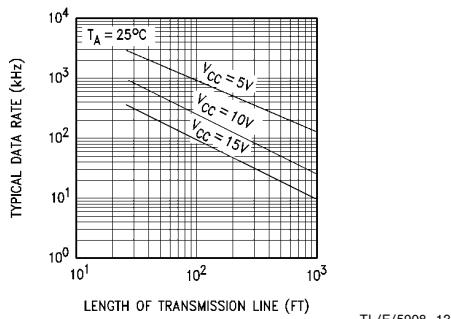
TL/F/5908-11



TL/F/5908-12

Note 1:  $V_{CC}$  is 3V to 15V

Typical Data Rate vs Transmission Line Length

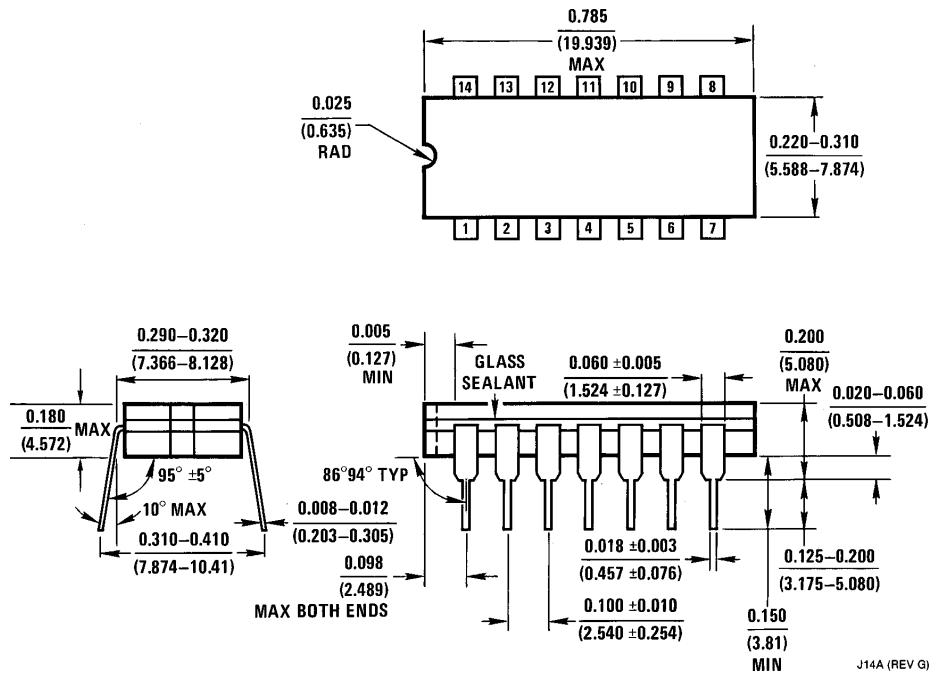


TL/F/5908-13

Note 1: The transmission line used was #22 gauge unshielded twisted pair (40k termination).

Note 2: The curves generated assume that both drivers are driving equal lines, and that the maximum power is 500 mW/package.

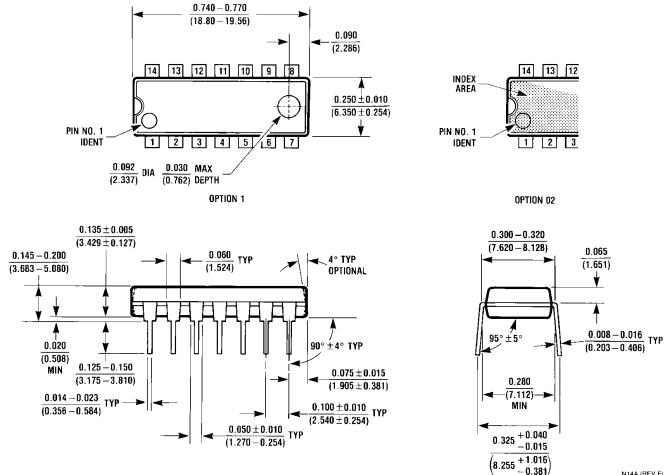
**Physical Dimensions** inches (millimeters)



J14A (REV G)

# MM78C29/MM88C29 Quad Single-Ended Line Driver MM78C30/MM88C30 Dual Differential Line Driver

## Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N)

Order Number MM78C29N, MM78C30N, MM88C29N or MM88C30N

NS Package Number N14A

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